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AMAOE Mbga-B17 BGA reballing platform with stencils for CPU SDM660/636 BGA254

Product ID: 22953

Price: **45.00 EUR**

Product weight: **1.00 kg**

Description:

AMAOE Mbga-B17 BGA reballing platform with stencils for CPU SDM660/636 BGA254- Reballing platforms are high-quality products that enable precise re-creation of balls connecting the upper and lower parts of the motherboard and for removing glue. Made of high-quality synthetic stone, resistant to high temperatures and quickly cooling down. Platforms equipped with very strong magnets that prevent movement during soldering work using templates / reballing sieves.

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